

Customer No.: 31561
Docket No.: 12595-US-PA
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In The Specification:

Please amend paragraph [0025] as follows:

[0025] FIG. 2 is a top view showing a polishing pad according to one preferred embodiment of the present invention, while Fig. 3A is a cross-sectional view along the line I-I' in FIG. 2A according to one preferred embodiment of the present invention. Referring to FIG. 2 and FIG. 3A, the polishing pad 200 has a polishing top surface 202 and a back surface 204, and the polishing pad 200 is divided into the polishing region 206 and the central region 210 neighboring to the polishing region 206. The top surface 202 is also called a polishing surface in the embodiments. In this preferred embodiment, the polishing pad 200 is made of, for example, polymer, such as polyurethane, epoxy resin, melamine, or other thermosetting resin.